PATENT

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Docket No.: 49677-091

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of

Shinichi YAMAGATA, et al.

Serial No.: 09/925,427

Filed: August 10, 2001

Customer Number: 20277

Confirmation Number: 5385

Group Art Unit: 1742

Examiner: Jenkins, Daniel J.

For:

SUBSTRATE MATERIAL FOR MOUNTING A SEMICONDUCTOR DEVICE, SUBSTRATE FOR

MOUNTING A SEMICONDUCTOR DEVICE, SEMICONDUCTOR DEVICE, AND METHOD OF

PRODUCING THE SAME

Mail Stop Non-Fee Amendment Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Dear Sir:

Transmitted herewith is an Amendment in the above-identified application.

No additional fee is required.

Applicant is entitled to small entity status under 37 CFR 1.27

Also attached:

The fee has been calculated as shown below:

	NO. OF CLAIMS	HIGHEST PREVIOUSLY PAID FOR	EXTRA CLAIMS	RATE	FEE
Total Claims	15	20	0	\$18.00 =	\$0.00
Independent Claims	2	3	0	\$84.00 =	\$0.00
		Multiple claims newly presented			\$0.00
		Fee for extension of time			\$0.00
					\$0.00
		Total of Above Calculations			\$0.00

Please charge my Deposit Account No. 500417 in the amount of \$0.00. An additional copy of	this
transmittal sheet is submitted herewith.	

The Commissioner is hereby authorized to charge payment of any fees associated with this communication or credit any overpayment, to Deposit Account No. 500417, including any filing fees under 37 CFR 1.16 for presentation of extra claims and any patent application processing fees under 37 CFR 1.17.

Respectfully submitted,

MCDERMOTT, WILL & EMERY

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Date: September 22, 2003

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AMENDMENT

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Sir:

Further to the Office Action dated June 18, 2003, reconsideration in light of the following remarks and claim amendment is respectfully solicited.